



# **SUSS MICROTEC – HALF YEAR FIGURES 2015**

August 6, 2015

#### DISCLAIMER

This presentation contains forward-looking statements relating to the business, financial performance and earnings of SUSS MicroTec AG and its subsidiaries and associates. Forward-looking statements are based on current plans, estimates, projections and expectations and are therefore subject to risks and uncertainties, most of which are difficult to estimate and which in general are beyond the control of SUSS MicroTec AG. Consequently, actual developments as well as actual earnings and performance may differ materially from those which explicitly or implicitly assumed in the forward-looking statements. SUSS MicroTec AG does not intend or accept any obligation to publish updates of these forward-looking statements.

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- SUSS MicroTec and NuFlare Technology agree on collaboration
- Large Orders in H1 2015 from Asian OSAT for improved coater ACS300 Gen2 and MA300 Mask Aligner products
- Improved position in temporary bonding with new order for XBS300 Gen2 from an Asian IDM
- + Annual Meeting 2015
- + Cooperation with the Georgia Institute of Technology

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- I. Highlights H1 2015
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# **KEY FINANCIALS**

in€ million	Q2 2015	Q2 2014	Change in %
Order Intake	41.2	36.2	13.8%
Order intake	41.2	30.2	13.070
Order Backlog 6/30	_	-	
Revenue	28.2	30.4	-7.2%
EBIT	-1.7	1.9	
EBIT in % of Sales	-6.0%	6.3%	
Earnings after tax	-2.1	0.9	
EPS in €	-0.11	0.05	
Free Cash Flow*	-7.7	1.8	
Net Cash**			
Employees 6/30	_		-

H1 2015	H1 2014
69.7	61.2
91.4	77.7
55.1	69.4
-3.9	3.4
-7.1%	4.9%
-4.6	2.0
-0.24	0.11
-13.2	-2.4
25.6	33.3
683	649

<sup>\*</sup> before consideration of purchased interest-bearing securities \*\*incl. stock of interest-bearing securities

#### **Frontend**

#### Mid- and Backend

#### **Photomask Equipment**

# Photomask Cleaning Equipment

#### **6M Figures 2015:**

Order Entry: 9.2 € million Sales: 9.7 € million

EBIT: 1.0 € million

#### Full Year Figures 2014:

Order Entry: 20.2 € million

Sales: 20.8 € million EBIT: 4.7 € million

### Lithography

Laser Processing Equipment

**Exposure** Systems

Coaters and Developers

#### **Substrate Bonder**

#### Wafer Bonding Equipment

Order Entry: 53.9 € million

Sales: 36.6 € million EBIT: -1.5 € million Order Entry: 3.4 € million

Sales: 5.1 € million EBIT: -1.7 € million

Order Entry: 91.5 € million

Sales: 96.7 € million EBIT: 10.7 € million

Order Entry: 17.2 € million

Sales: 22.4 € million EBIT: -2.4 € million

#### **SUSS MicroTec Group**

6M Order Entry: 69.7 € million

6M Sales: 55.1 € million

FY 2014\*:

Order Entry: 134.3 € million

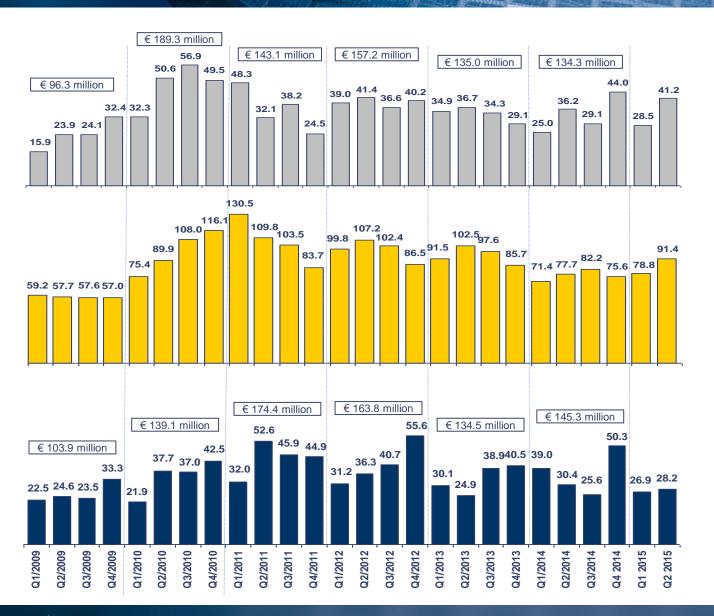
Sales: 145.3 € million

6M EBIT: -3.9 € million 6M EBIT-Margin: -7.1%

EBIT: 8.4 € million EBIT-Margin: 5.8%

<sup>\*</sup> FY 2014, EBIT Segment Others: -4.5 € million H1 2015, EBIT Segment Others: -1.7 € million

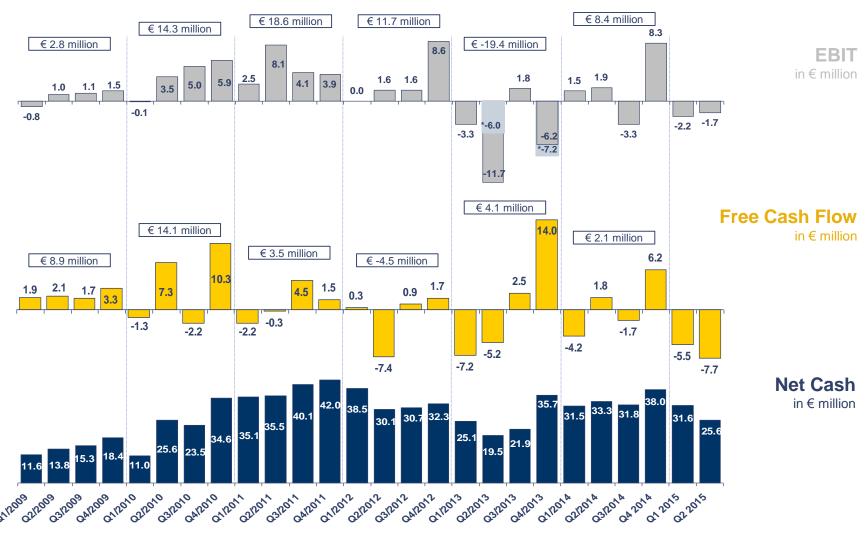
# LONG TERM BUSINESS DEVELOPMENT BY QUARTER



Order Entry in € million

Order Backlog in € million

Sales in € million



<sup>\*</sup> one-off effect from restructuring the product line permanent bonding

## STRATEGY UPDATE - INITIAL VISION STATEMENTS

- The recognized leader in Advanced Packaging and adjacent segments
- The Trusted Choice for our customers
- A provider of Integrated Processing Solutions
- An Innovator and Enabler of customer roadmaps
- A Growth Company, as recognized by customers, peers, and investors

# STRATEGY UPDATE - HIGH LEVEL OBJECTIVES

#### Achieve attractive revenue growth rates

- Expand Market Size for Existing Products
  - + Achieve further traction for Scanner products in Advanced Packaging (ADP: Fan Out, Cu Pillar)
  - + Leverage traditional Mask Aligner technology to win market share in growing MEMS market
  - + Reverse market share loss in Coater / Developer business with new high productivity platform and retrofitable upgrades for large installed base
- Explore new adjacent markets
- Grow Market Share
  - + Improve responsiveness and support for existing customers further in order to enable more repeat buys
  - + Define and implement a more targeted key (new) customer penetration strategy
- Focus Product Portfolio
  - + Target technology leadership through product differentiation in Advanced Packaging (ADP), MEMS, and FE segments to enable value propositions to our customers
  - + Target lowest Cost of Ownership and product cost in competitive commodity market environments

#### Reliable profitability, solid EBIT and cash generation

- Drive aggressive product cost of sales reduction programs to improve product gross margin
- Improve R&D and product release cycle time through Product Life Cycle management, change control methodology, clear priorities, accountabilities, and visible metrics

# **OUTLOOK PER PRODUCT LINE**

Lithography	Current and expected sales level around 80 – 90 € million per year  UV Projection Scanners and Laser Ablation Steppers:  Current annual sales at around 10 € million		
Photomask Equipment	Stable sales level at around 20 € million per year		
Substrate Bonders	Permanent Bonding and Temporary Bonding:  Expected sales level of the division: 15 – 20 € million		
Outlook	FY 2015: Sales: 135 - 145 € million EBIT: slightly positive  Q3 2015: Order Intake: 25 - 35 € million		

Q4 2015: Order Intake: 30 - 40 € million

**Mask Aligner and Coaters / Developers:** 

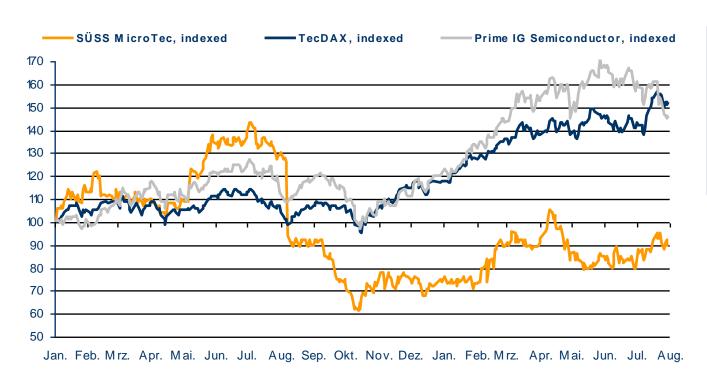
# Thank you

SÜSS MicroTec AG Schleissheimer Str. 90 85748 Garching

www.SUSS.com

## SHARE PRICE DEVELOPMENT AND MAJOR HOLDERS

(Price of the SUSS MicroTec Share at January 2, 2014: 6.38 €)



#### **Major Shareholders:**

Henderson 5.1%

Universal 5.0%

Sycomore 3.1%

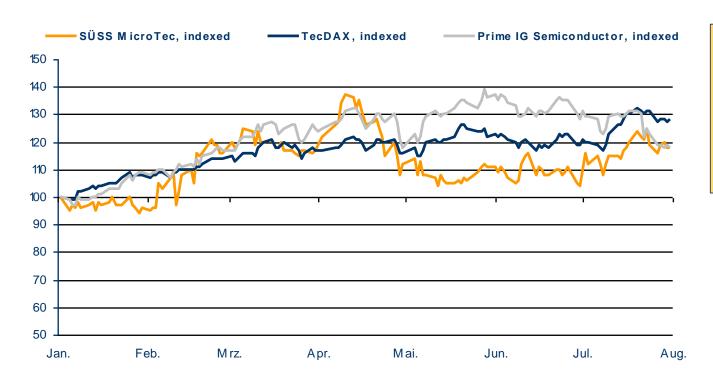
INKA 3.1%

Baillie Gifford 3.0%

Average daily trading volume January 2014 – July 2015: ~ 126,000

# SHARE PRICE DEVELOPMENT AND MAJOR HOLDERS

(Price of the SUSS MicroTec Share at January 2, 2015: 4.88 €)



#### **Major Shareholders:**

Henderson 5.1%

Universal 5.0%

Sycomore 3.1%

INKA 3.1%

Baillie Gifford 3.0%

**Average daily trading volume January – July 2015: ~ 144,000** 

# ORDER ENTRY AND SALES BY SEGMENT AND REGION

